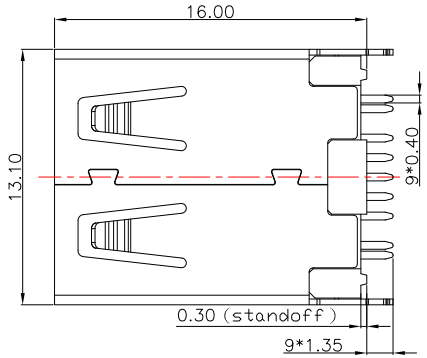
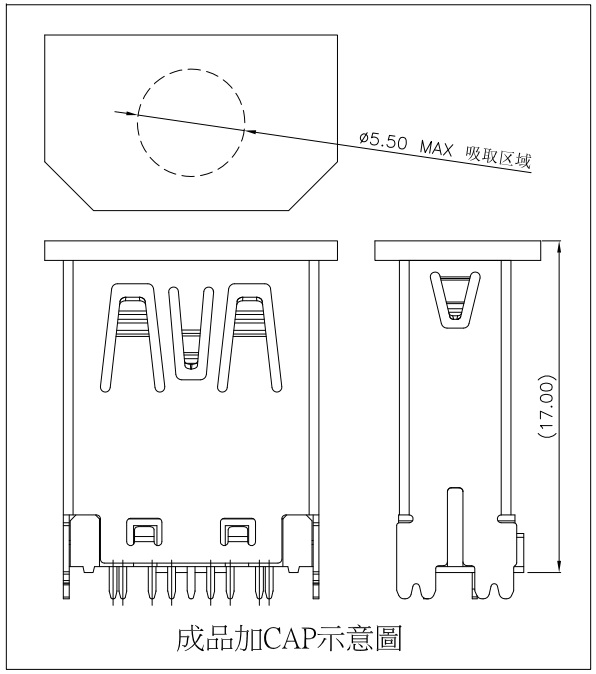
SUA-110V9-30x-S410

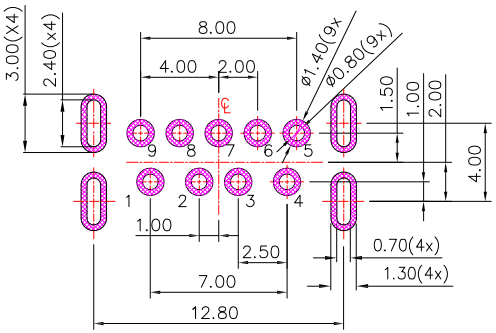
鍍層厚度：

Blank : 1u"
2 : 15u"
3 : 30u"

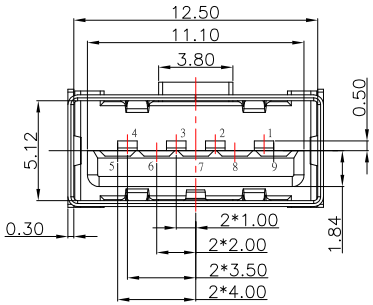


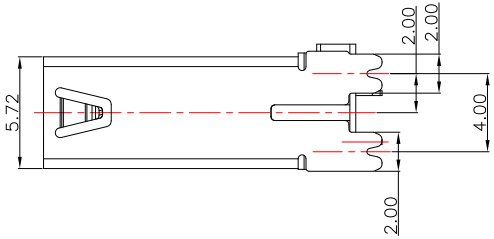


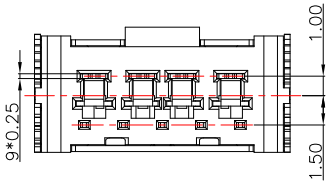
成品加CAP示意圖

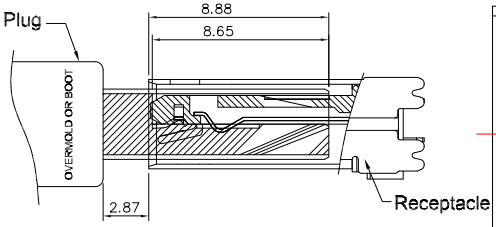


RECOMMENDED PCB LAYOUT

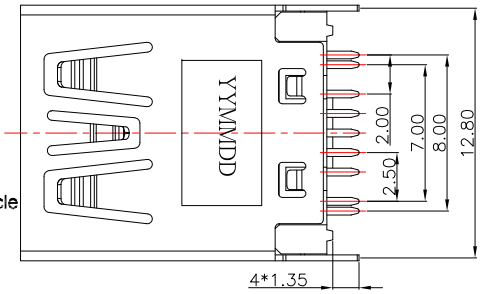








Mated Condition



Pin NUMBER	SIGNAL NAME
1	VBUS
2	D-
3	D+
4	GND
5	StdA_SSRX-
6	StdA_SSRX+
7	GND_DRAIN
8	StdA_SSTX-
9	StdA_SSTX+
Shell	Shield

NOTE:

1.MATERIAL:

1.1 Housing: LCP

1.2 Contact: Phosphor Bronze

1.3 Shell: SUS

2.Finish:

2.1 Contact: Plated Gold in Mating Area ;
Tin Plated on Solder Balls ;
Nickel under plated overall

2.2 Shell: Nickel under Plated surface layer

ITEM NO.	DESCRIPTION	DRAWN	DATE

CONTACT 建倚科技股份有限公司
CONTACT TECHNOLOGY CORP.

TOLERANCE UNLESS OTHERWISE STATED : Up to 5 ±0.2; Above 5 ~ 15 ±0.3; Above 15 ~ 30 ±0.4; Above 30 ~ 50 ±0.5; Angle ±0.3°

3RD. ANGEL'S | UNITS MM

DRAWN BY: Jack Lu	DATE 09/14/22	MAT'L	
CHECKED BY: Jacky Chen	DATE 09/14/22	FINISH	
APPROVED BY: Tony Kao	DATE 09/14/22	SCALE 1 : 1	SHEET NO. 1 of 1

TITLE	CONNECTOR		
MODLE	USB 3.0 AF 180度 H16.00 DIP 端子腳長1.35		
DWG NO.	SUA-110V9-30x-S410	SIZE	A4
PART NO.	SUA-110V9-30x-S410	VER	R